



LG

LG-355PT2C94F-928

PHOTO TRANSISTOR

DATA SHEET

SPEC. NO. : SZ20111604
DATE : 2021/05/21
REV. : A/3

Approved By:

Checked By:

Prepared By:

Part No. **LG-355PT2C94F-928**

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LG-QR-R009-01

LIGHT ELECTRONICS CO., LTD.

Photo Transistor Diode Specification

●Commodity: Photo Transistor

●Ic(on) Bin Code ($V_{CE}=5V$, $E_e=1mW/cm^2$, $\lambda_p=940nm$)

BIN CODE	Min. (mA)	Max. (mA)
X2	3.7	4.4
X3	4.4	5.3



LED MOUNTING METHOD

1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures (Fig.1).

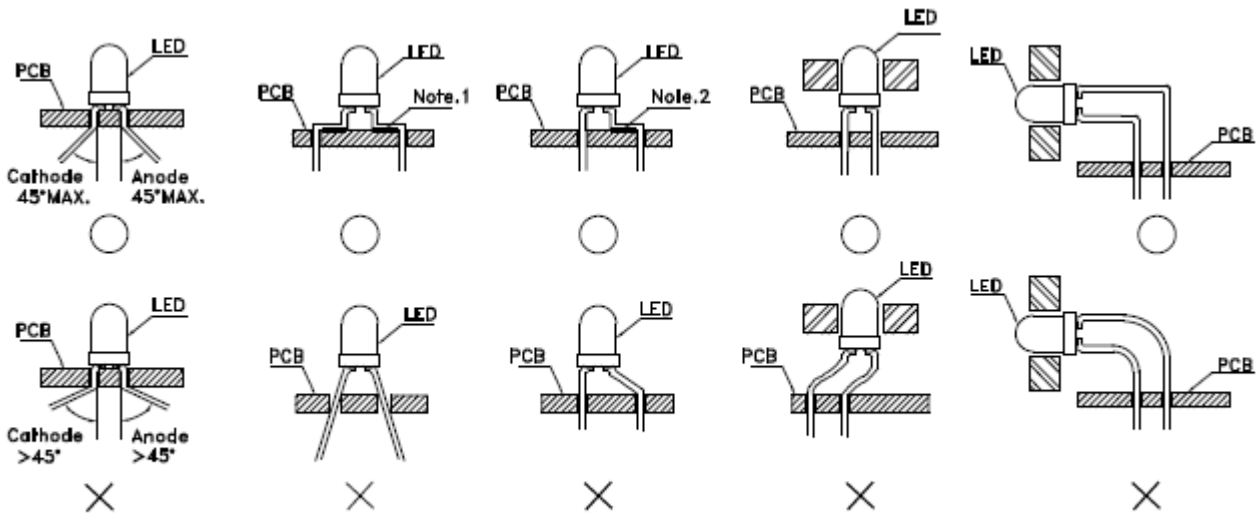


Fig. 1

“ ” Correct mounting method “X” Incorrect mounting method

Note 1-2: Do not route PCB trace in the contact area between the lead frame and the PCB to prevent short-circuits.

2. When soldering wire to the LED, use individual heat-shrink tubing to insulate the exposed leads to prevent accidental contact short-circuit (Fig.2).

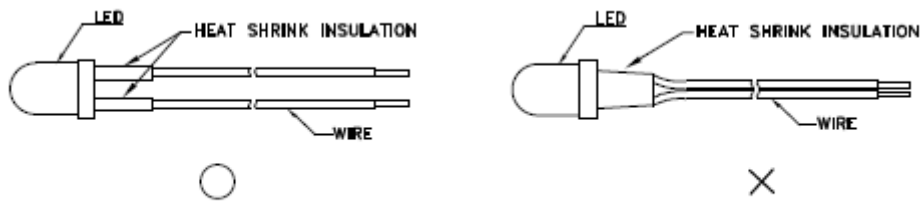


Fig. 2

3. Use stand-offs (Fig.3) or spacers (Fig.4) to securely position the LED above the PCB.

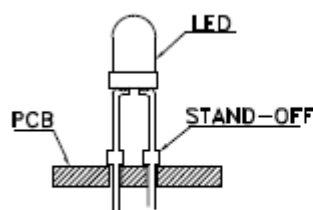


Fig. 3

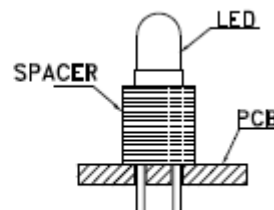
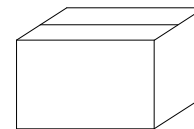
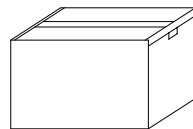
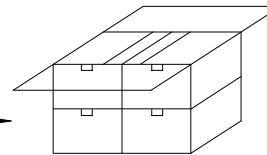
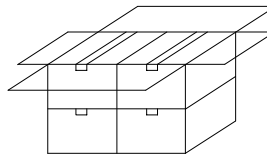
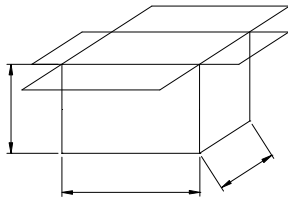
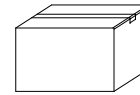
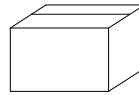
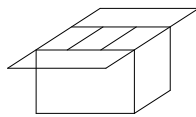
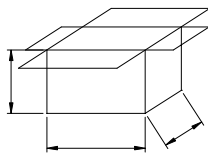
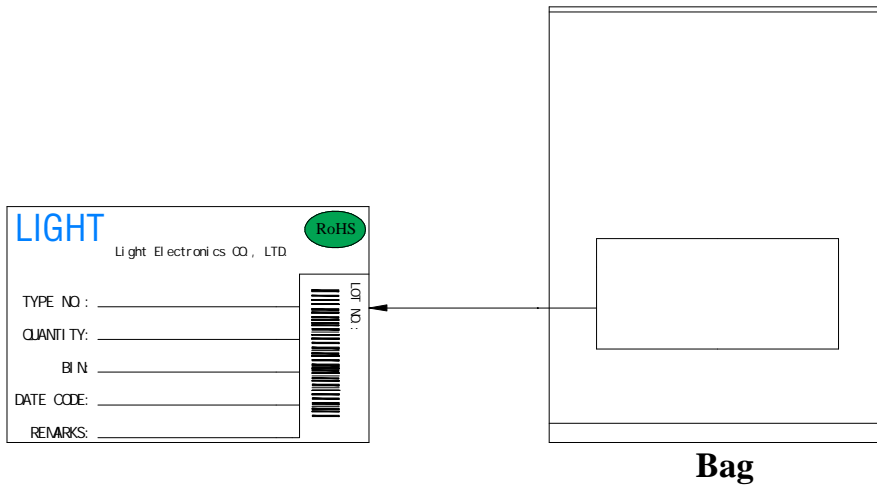


Fig. 4

PACKAGE



Bag minimum volume (pcs / Bag)	Bag volume (pcs / Bag)	Inner box volume (Bag / box)	Outer carton volume (Box / Carton)
500	1000	10	4